

TPS7H2201EVM-CVAL Evaluation Module (EVM) User's Guide

The TPS7H2201EVM-CVAL is the Evaluation Module (EVM) for the TPS7H2201-SP and provides a platform to electrically evaluate its features. This user's guide provides details about the EVM, its configuration, schematics and BOM.

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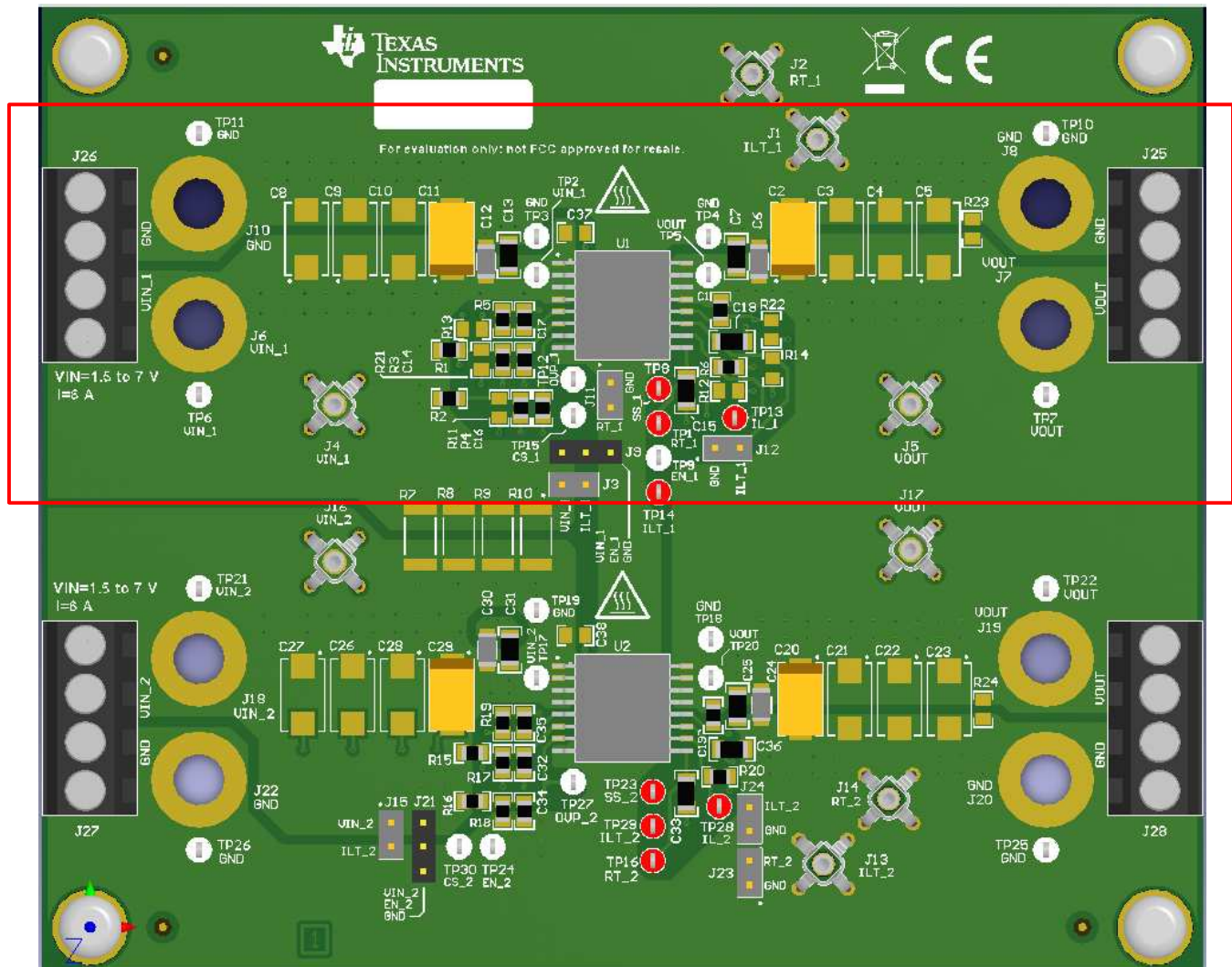
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1 Introduction

The TPS7H2201-SP device is a single channel, 6-A load switch with a programmable slew rate for applications that require specific rise-time as well as programmable current limit for protection purposes. In addition, the TPS7H2201-SP features a reverse current protection capability for redundancy applications as well as programmable fault timers. The device contains a P-channel MOSFET that can operate over an input voltage range of 1.5 V to 7 V and can support a maximum continuous current of 6 A. The switch is controlled by an on and off input (EN), which is capable of interfacing directly with low-voltage control signals.



NOTE: The red line indicates the section of the EVM populated for the single version. For dual version, both sections are populated.

Figure 1. TPS7H2201EVM-CVAL EVM Board

2 EVM Configuration

The EVM is designed to be used across the entire input voltage and output current range of the TPS7H2201-SP while providing flexibility in configuring the device under different conditions. By default, the device in the EVM is configured as shown in [Table 1](#). To configure the device in a different configuration, please refer to the TPS7H2201-SP data sheet to calculate the values of the passives around the device that would need to be changed.

Table 1. Input Voltage and Output Current Summary for the TPS7H2201EVM-CVAL

Specification	Value
EN threshold	4.85 V
UVLO threshold	3.7 V
OVP threshold	6 V
Current limit, IL	7.5 A
Current limit timer, ILTIMER	1 ms
Retry timer, RTIMER	1 ms
Soft start	9 ms
Maximum CS pin voltage	4.6 V

The EVM provides connectors and test points to access every pin of the device. [Table 2](#) shows the description of these connectors and test points.

Table 2. EVM Connectors and Test Points

Reference Designator	Function
J6, TP6	VIN for U1 (single board).
J10, TP11	GND for U1 (single board).
J4	Cold probe connector for VIN1.
J7, TP7	VOUT for U1 (single board).
J8, TP10	GND for VOUT1 (single board).
J5	Cold probe connector for VOUT1.
J1	Cold probe connector for ILTIMER for U1 (single board).
J2	Cold probe connector for RTIMER for U1 (single board).
TP9	Test point for EN1.
TP12	Test point for OVP1.
TP15	Test point for CS1.
TP8	Test point for SS1.
TP1	Test point for RTIMER1.
TP14	Test point for ILTIMER1.
TP13	Test point for IL1.
J9	EN1 jumper selection (pins 1-2: VIN, pins 2-3: GND).
J3	ILTIMER1 jumper selection (closed: VIN1, internal current limit timer selected).
J12	ILTIMER1 jumper selection (closed: GND, internal current limit timer and retry timer both disabled).
J11	RTIMER1 jumper selection (closed: GND, retry timer disabled until EN1 pin is cycled).
TP2, TP5	Test points VIN1 and VOUT1 respectively for U1 RDSon measurements.
J18, TP21	VIN for U2 (dual board).
J22, TP26	GND for VIN2 (dual board).
J16	Cold probe connector for VIN2.
J19, TP22	VOUT for U2 (dual board).
J20, TP25	GND for VOUT2 (dual board).
J17	Cold probe connector for VOUT2.
J13	Cold probe connector for ILTIMER for U2 (dual board).

Table 2. EVM Connectors and Test Points (continued)

Reference Designator	Function
J14	Cold probe connector for RTIMER for U2 (dual board).
TP24	Test point for EN2.
TP27	Test point for OVP2.
TP30	Test point for CS2.
TP23	Test point for SS2.
TP16	Test point for RTIMER2.
TP29	Test point for ILTIMER2.
TP28	Test point for IL2.
J21	EN2 jumper selection (pins 1-2: VIN, pins 2-3: GND).
J15	ILTIMER2 jumper selection (closed: VIN2, internal current limit timer selected).
J24	ILTIMER2 jumper selection (closed: GND, internal current limit timer and retry timer both disabled).
J23	RTIMER2 jumper selection (closed: GND, retry timer disabled until EN1 pin is cycled).
TP17, TP20	Test points VIN2 and VOUT2 respectively for U2 RDSon measurements.
TP3, TP4, TP18, TP19	GND.

2.1 EVM Variants

There are 2 variants of the EVM, both using the same PCB. [Table 3](#) shows these variants

Table 3. TPS7H2201-SP EVM Variants

EVM Orderable Name	Assembly Name	Description
TPS7H2201EVM-CVAL	SLHR008-001	Single version.
TPS7H2201EVMCVAL-D	SLHR008-002	Dual version for redundancy or parallel configuration.

In the single variant of the EVM, the components associated with the dual variant are not populated. The dual variant has the VOUT of both load switches connected. This allows testing for 2 different main applications:

1. **Redundancy** - This is the default configuration of the dual variant EVM. In this case, each load switch will have a different VIN source but a common VOUT. The common VOUT is already implemented by default in both variants of the EVM. In this configuration, each load switch will have its own passives.
2. **Parallel operation** - In this configuration, both switches will have the same VIN source as well as a common VOUT. To connect the VIN for both switches, there are footprints for 4, size 2512, 1-W, 0-Ω resistors (R7, R8, R9 and R10) in parallel that will need to be populated. In addition, when in parallel application, the master load switch (U1) must drive the EN, OVP, CS, SS, RTIMER and ILTIMER pins of the slave device (U2). As a result, there are footprints for 0-Ω resistors (R21, R11, R13, R22, R12 and R14 respectively) that need to be populated to connect these pins from one device to another. The passives for U2, except for the IL pin, that are populated by default for redundancy application would also need to be removed for parallel operation. [Figure 2](#) and [Figure 3](#) show the redundancy and the parallel operation applications highlighting the all the resistors previously mentioned.

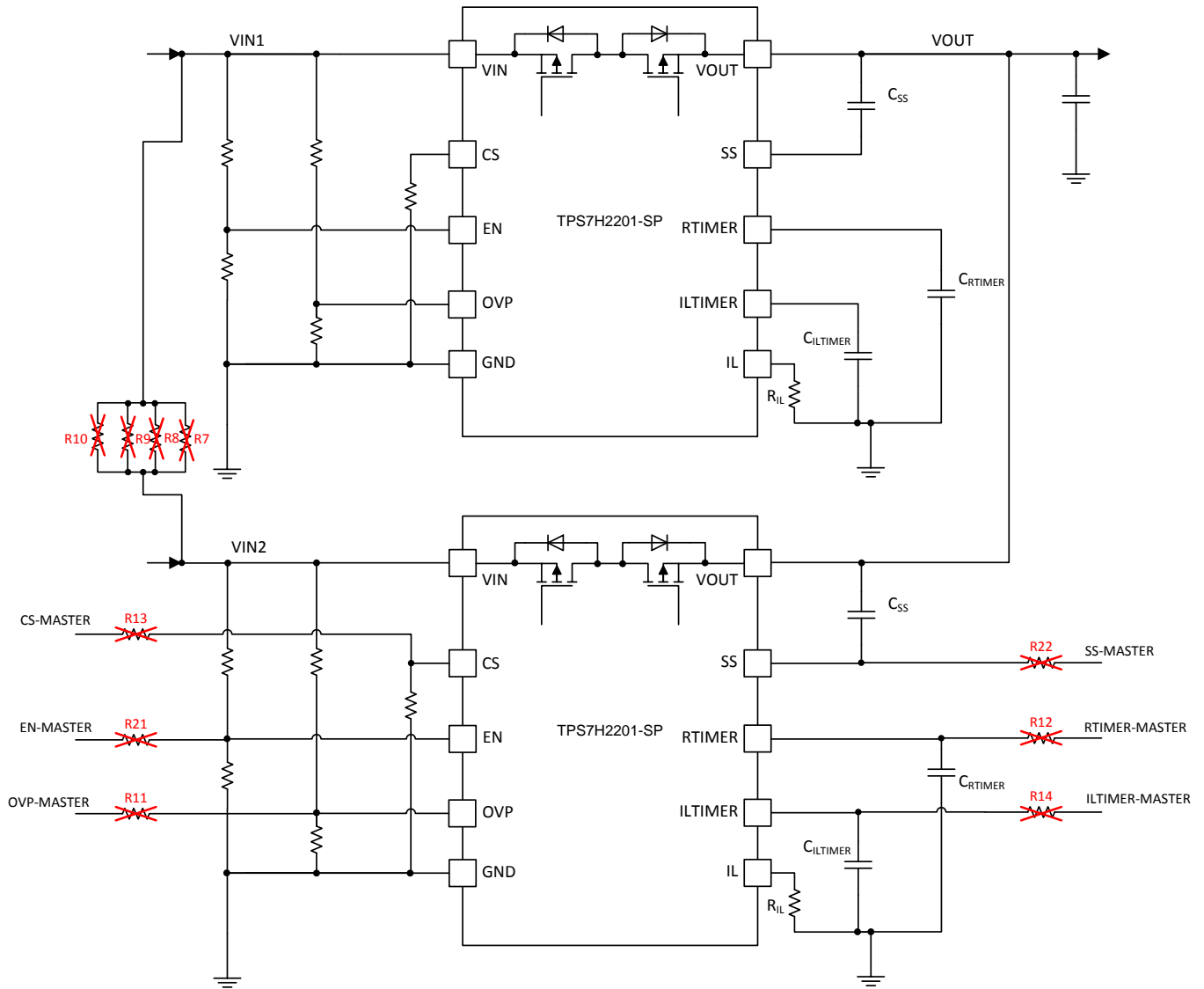


Figure 2. Redundancy Configuration for TPS7H2201EVMCVAL-D

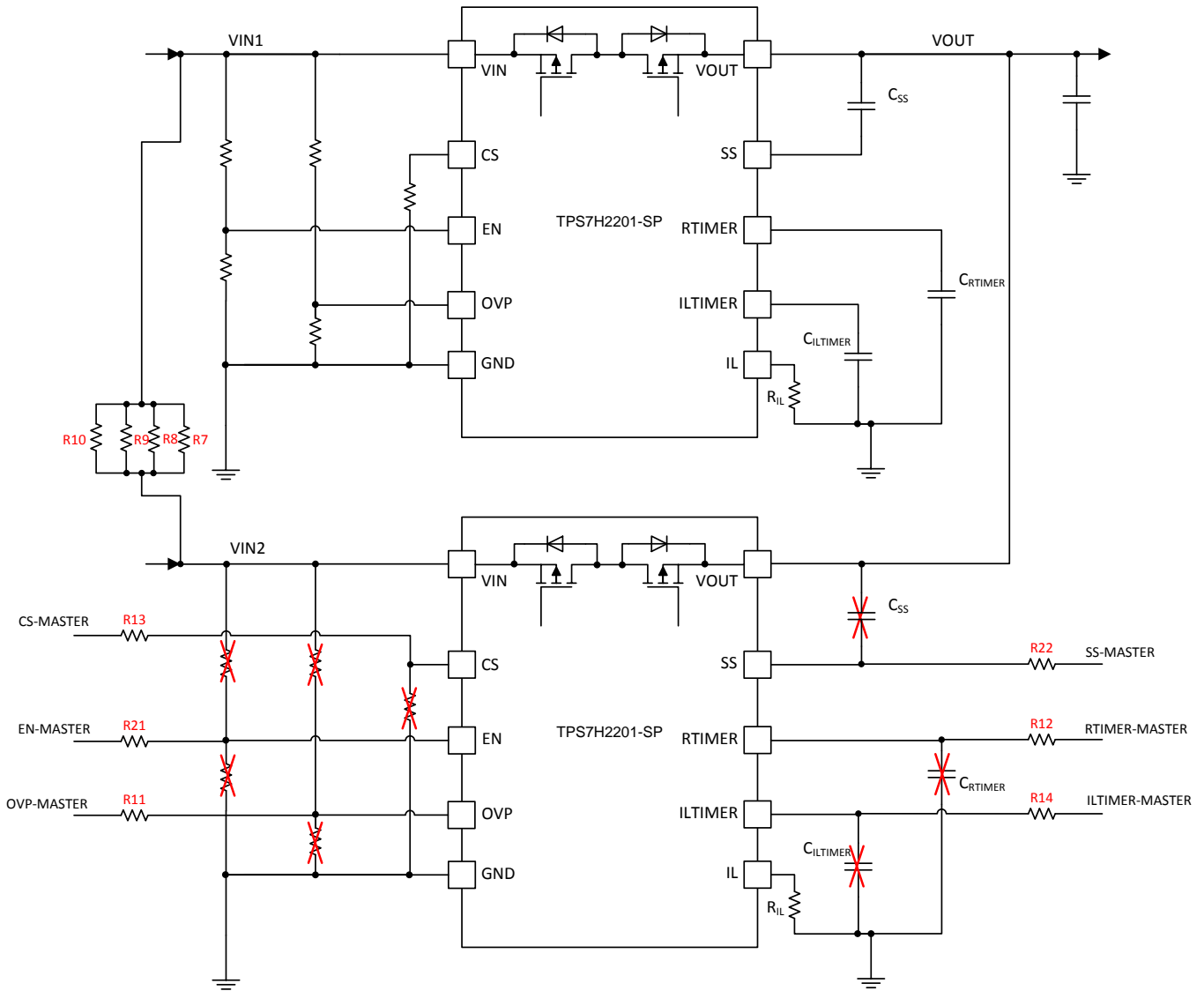


Figure 3. Parallel Configuration for TPS7H2201EVMCVAL-D

3 Test Setup and Results

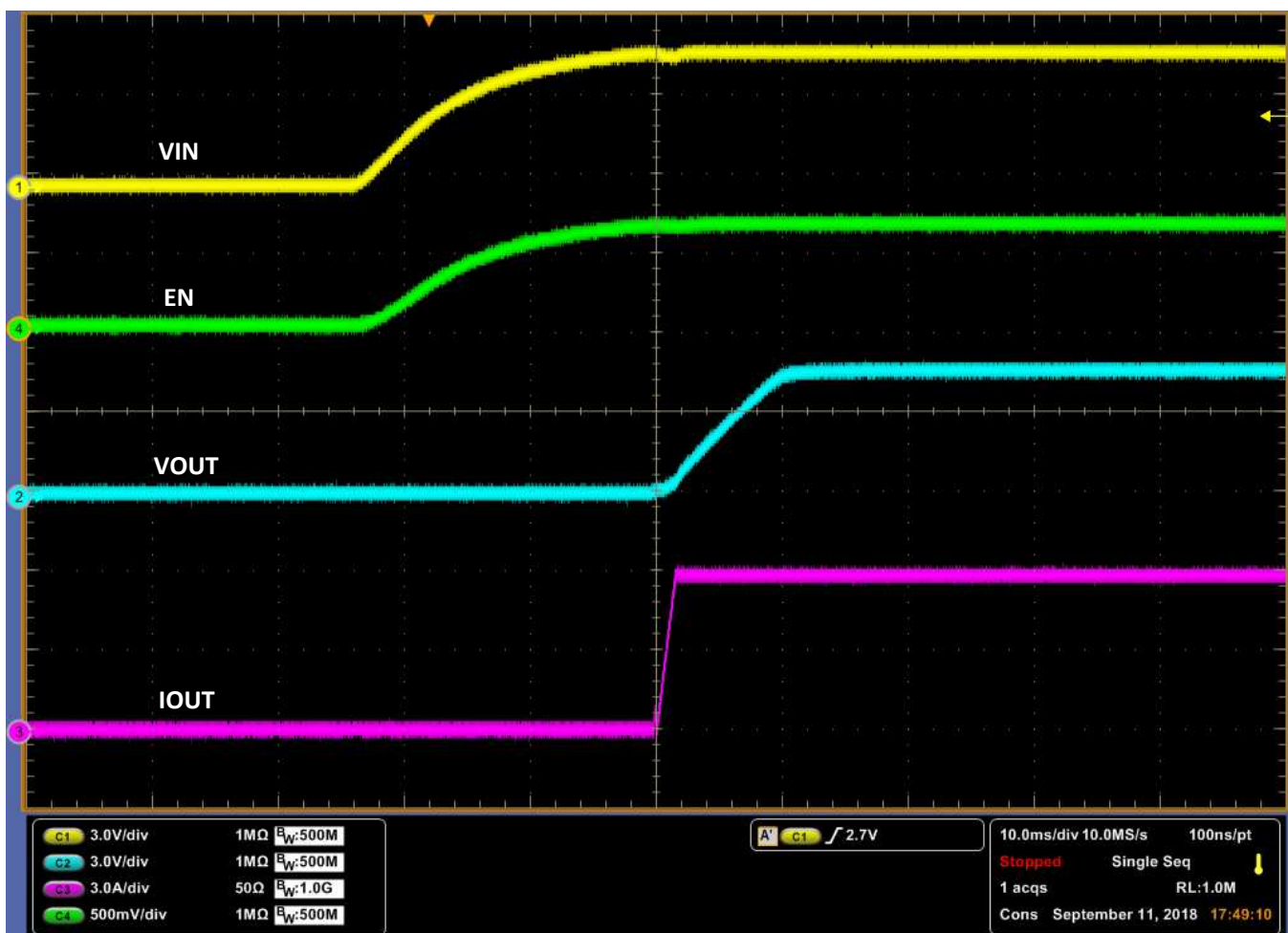
The following sections highlight some of the features of the load switch.

CAUTION

Please notice that under extreme fault conditions (a constant GND short on the output for example) and if the device is configured for current limit and retry mode, the amount of power dissipated by the device will be very large and as a result the board might get hot quickly.

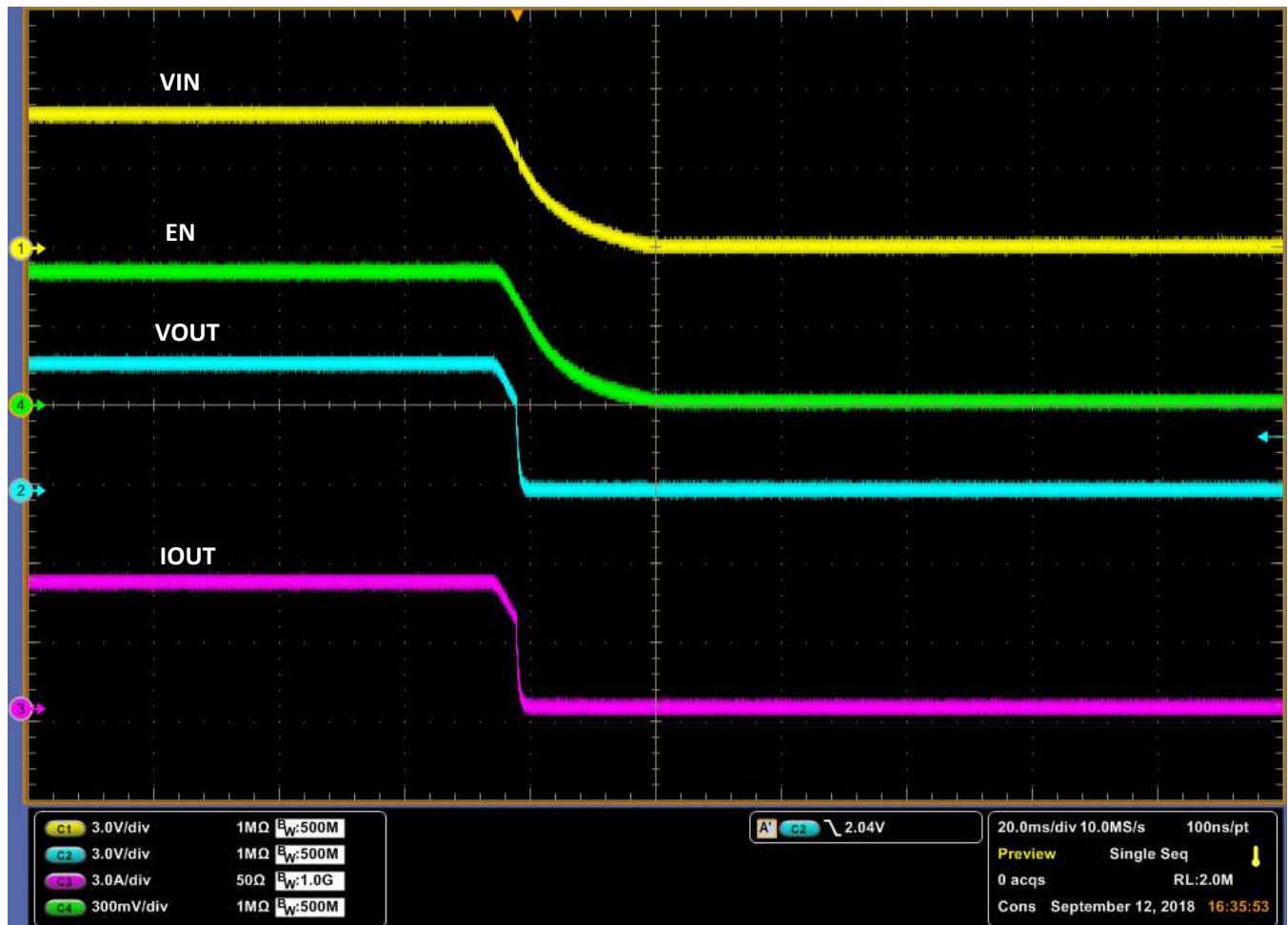
All tests were performed using the TPS7H2201EVM-CVAL in its default configuration at $V_{IN} = 5\text{ V}$ with the configuration shown in [Table 1](#).

3.1 Power Up and Power Down



NOTE: The VIN trace shows the enable threshold for the device set by the resistor divider to be about 4.85 V. The EN trace shows the EN pin voltage rising to 0.6 V as indicated in the data sheet. The SS time of about 9 ms can be observed having a 6-A output load.

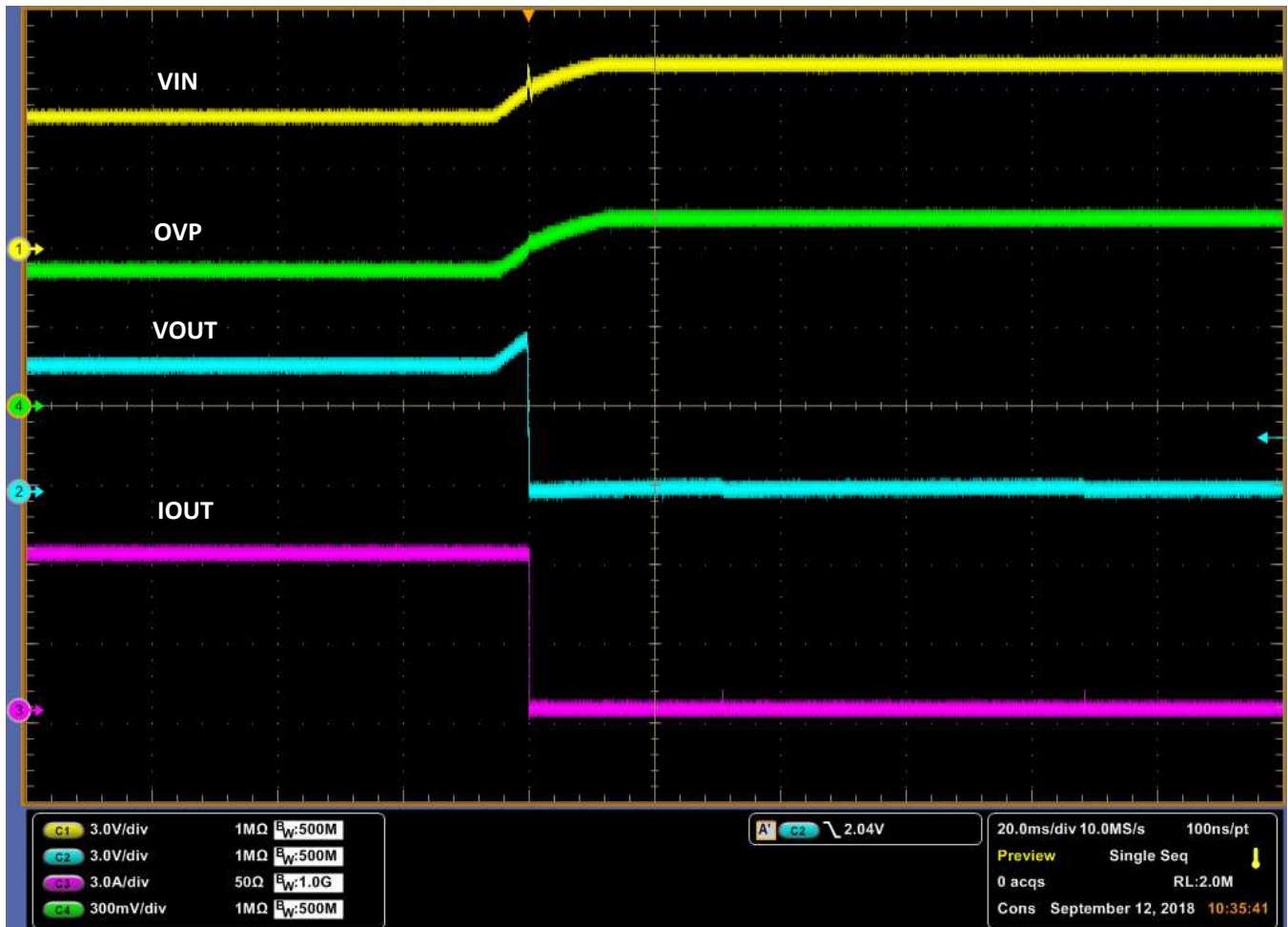
Figure 4. Power-up Behavior of the TPS7H2201-SP



NOTE: The VIN trace shows the UVLO threshold for the device set by the resistor divider to be about 3.7 V. Up until this point, VOUT followed VIN before the switch opens. The EN trace shows the EN pin voltage falling to about 0.5 V as indicated in the data sheet.

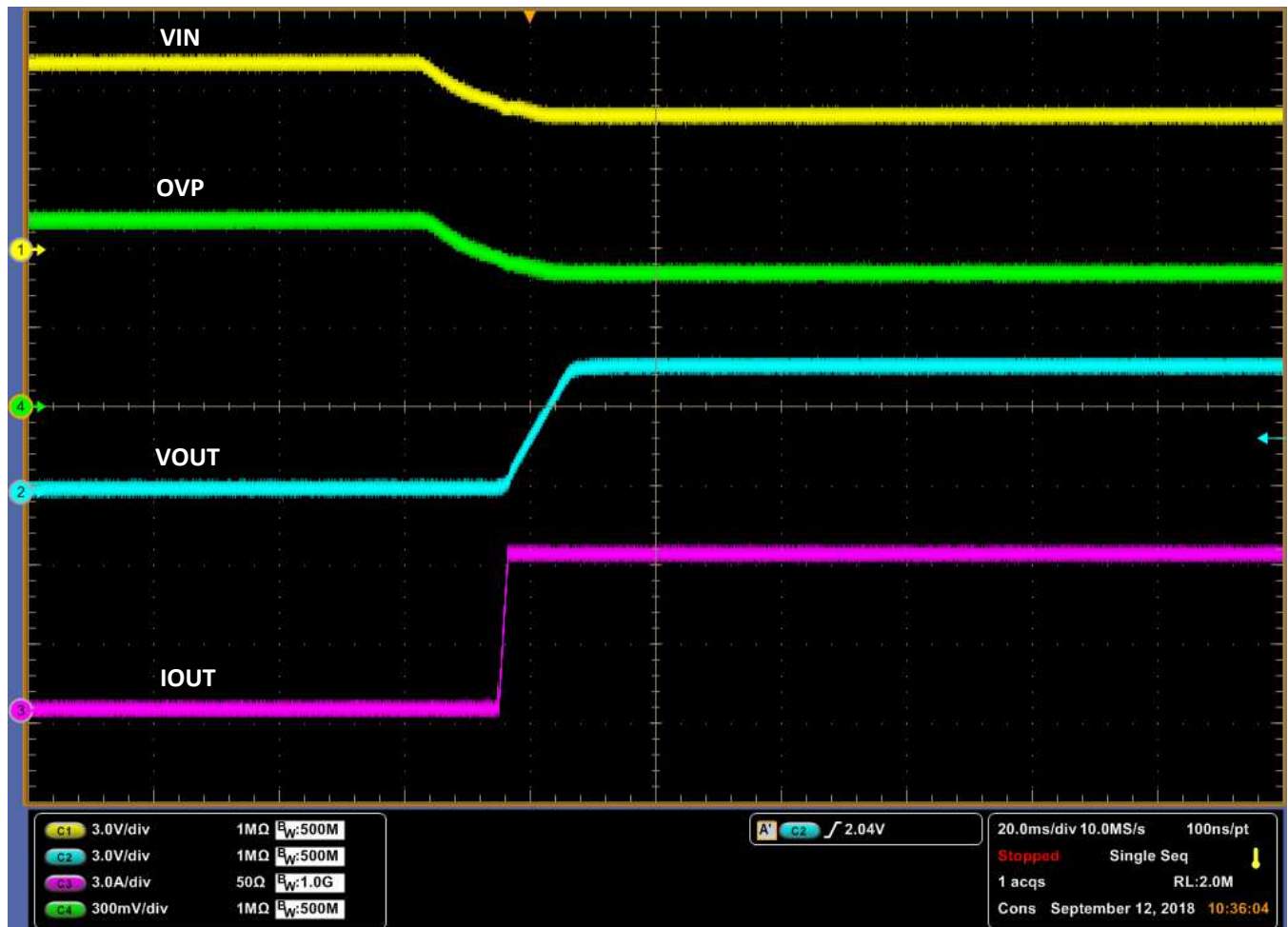
Figure 5. Power-down Behavior of the TPS7H2201-SP

3.2 Overvoltage Protection



NOTE: The switch opens at VIN = 6 V and the OVP pin trace shows to be about 0.6 V as indicated in the data sheet. Up until this point, VOUT followed VIN.

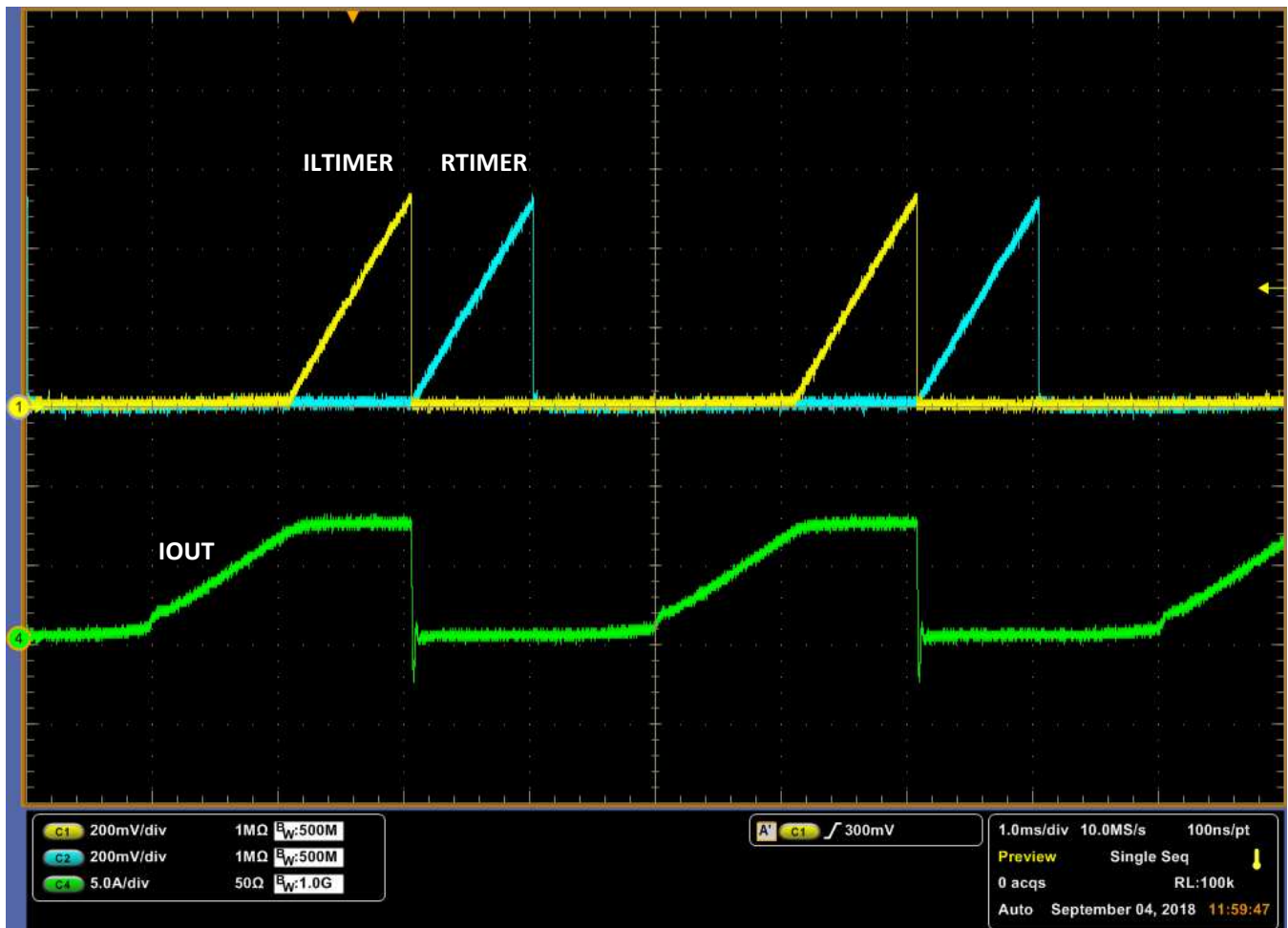
Figure 6. OVP Assertion at VIN = 6 V Opening the Switch



NOTE: After VIN returns to about 5.2 V, the OVP pin trace shows to be about 0.52 V as indicated in the data sheet. The switch closes again in SS mode. The SS time of about 9 ms can be observed having a 6-A output load.

Figure 7. OVP Deassertion by Returning VIN = 5 V

3.3 Programmable Fault Timers



NOTE: The 1-ms programmed time can be observed for each timer. The rising IOUT prior to each ILTIMER waveform shows the switch detecting the current limit and slowly increasing the current until IL is reached. The time after the RTIMER expires and the next cycle restarts (assuming fault condition is still present) is due to the gate of the switch being slowly driven between fault conditions.

Figure 8. ILTIMER and RTIMER Waveforms When IL is Set to 7.5 A

4 Board Layout

The EVM consists of 4 layers, 2-oz copper, for a total thickness of 62 mil. The layout flows from left (VIN) to right (VOUT) with the input and output capacitors placed as close as possible to the TPS7H2201-SP. Layer 1 contains power planes for VIN1, VIN2, VOUT and GND as well as some signal routing, layer 2 is all GND, layer 3 is GND plus some signal routing and layer 4 contains power planes for VIN1, VIN2, VOUT and GND. Vias under the TPS7H2201-SP allow a thermal path from the top layer all the way to the bottom layer. The EVM does not populate all the input and output capacitors for the TPS7H2201-SP but it allows customers to populate more as needed as the footprints are part of the layout. While this provides flexibility to the customer for electrical evaluation, it does not truly reflect the best optimized area for the TPS7H2201-SP in a real application. The EVM layers are shown next.

The following images show the TPS7H2201EVM-CVAL EVM layers.

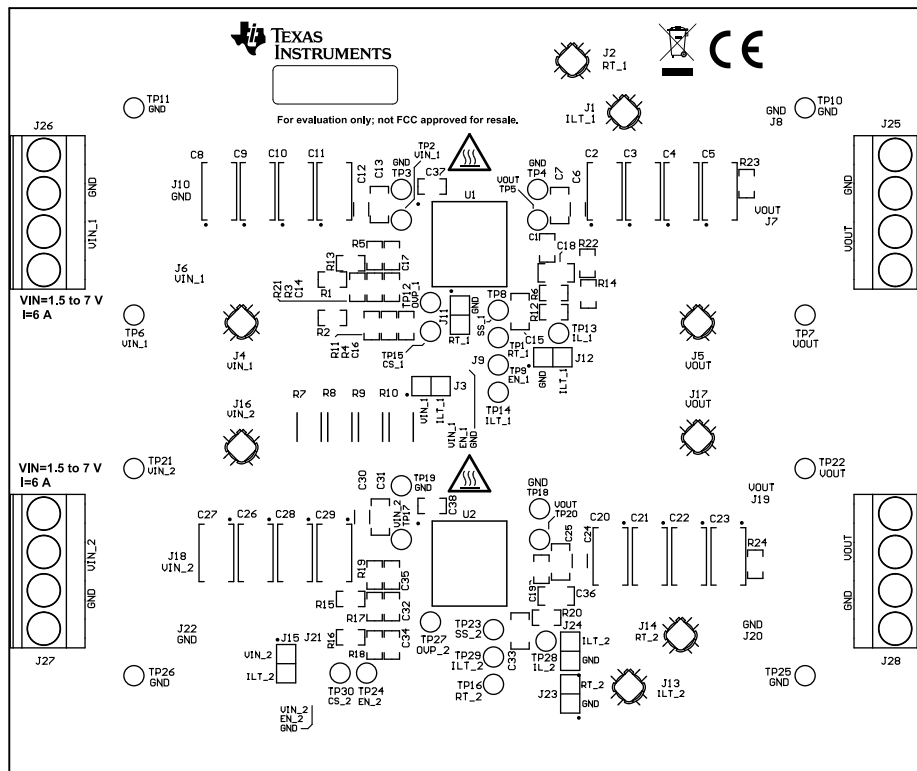


Figure 9. Top Overlay

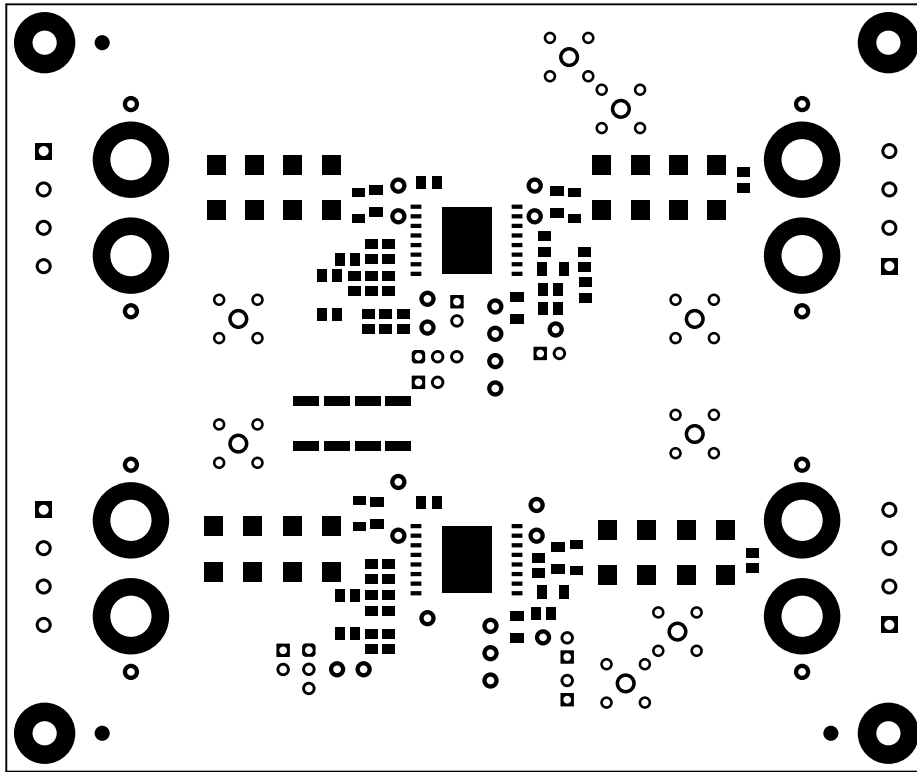


Figure 10. Top Solder Mask

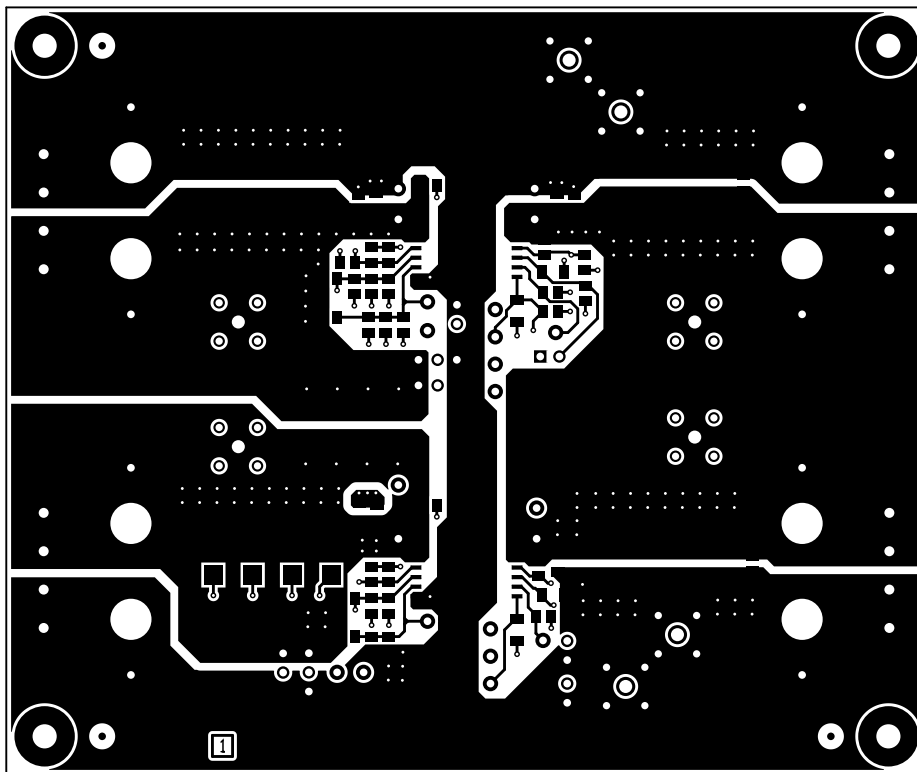


Figure 11. Top Layer

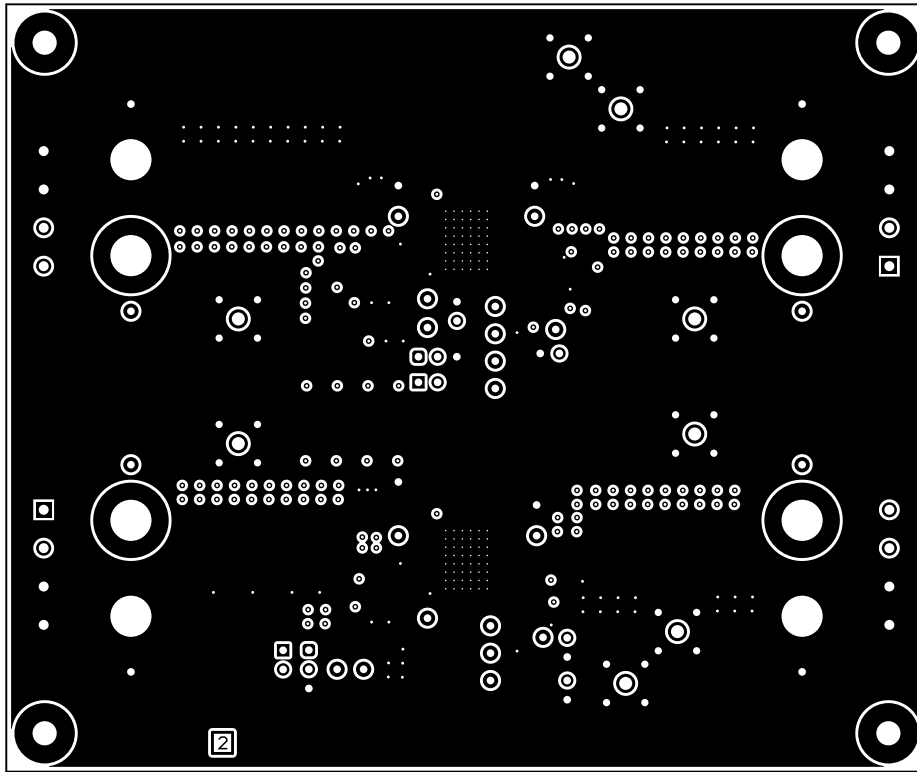


Figure 12. Signal Layer 1

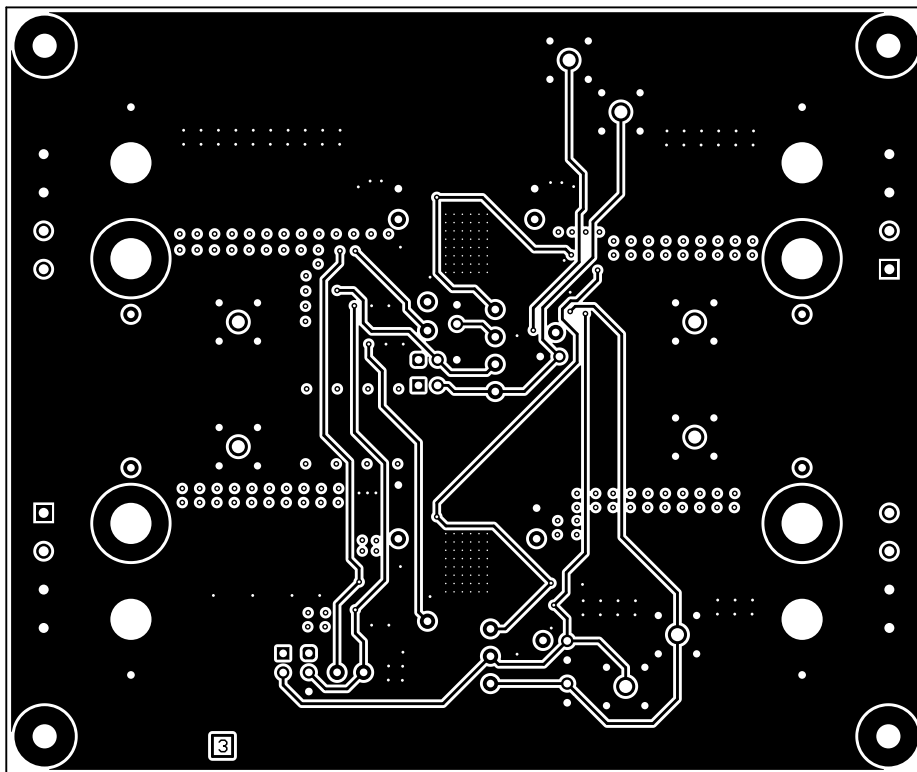


Figure 13. Signal Layer 2

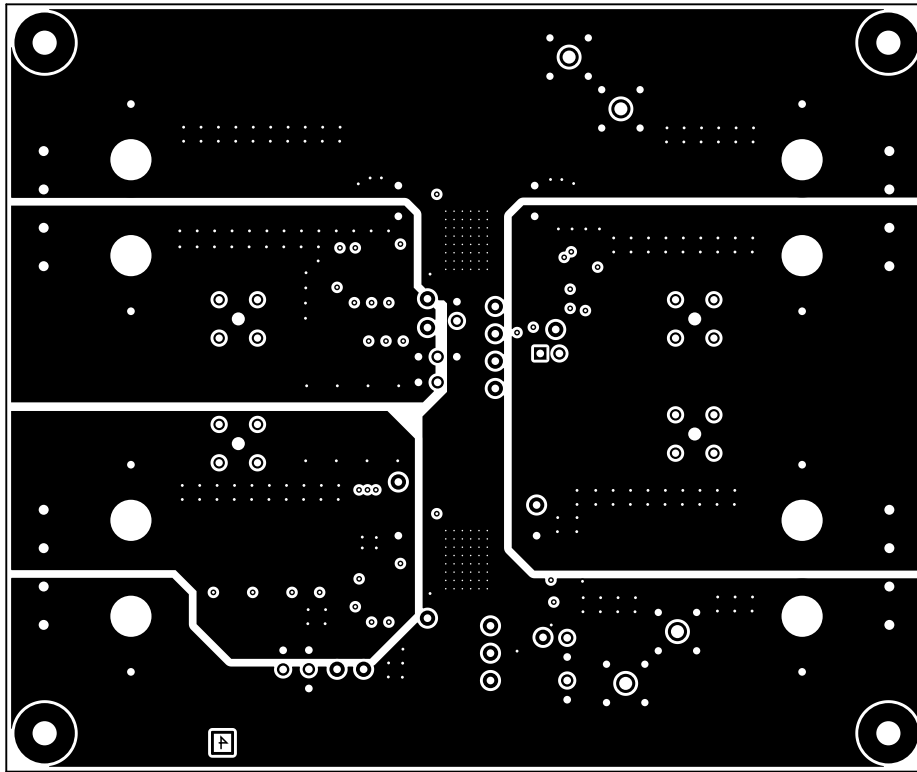


Figure 14. Bottom Layer

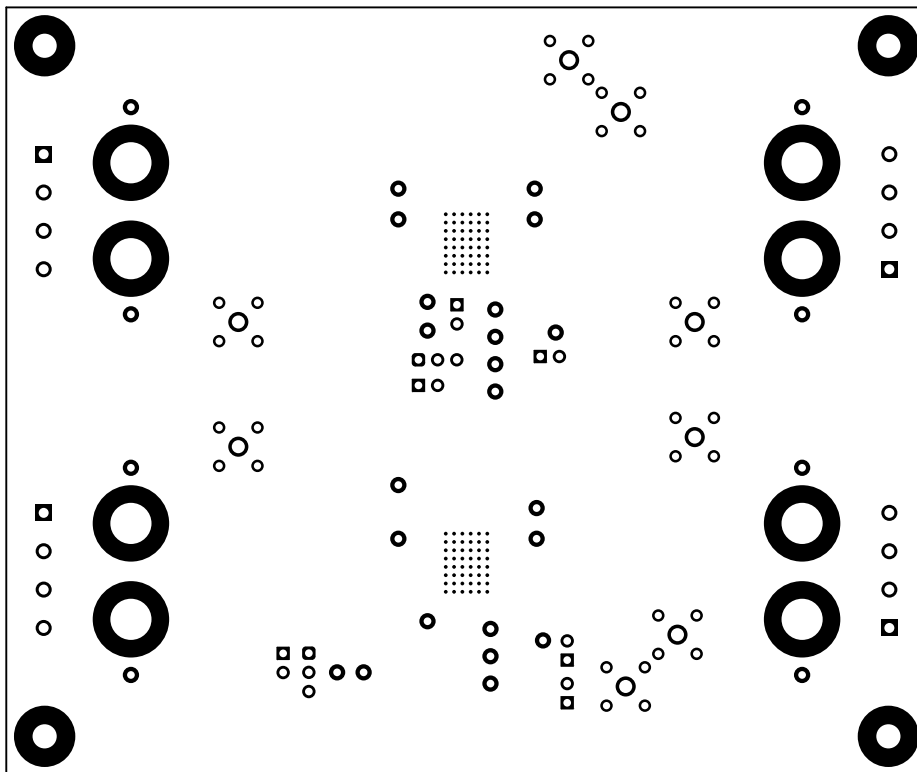
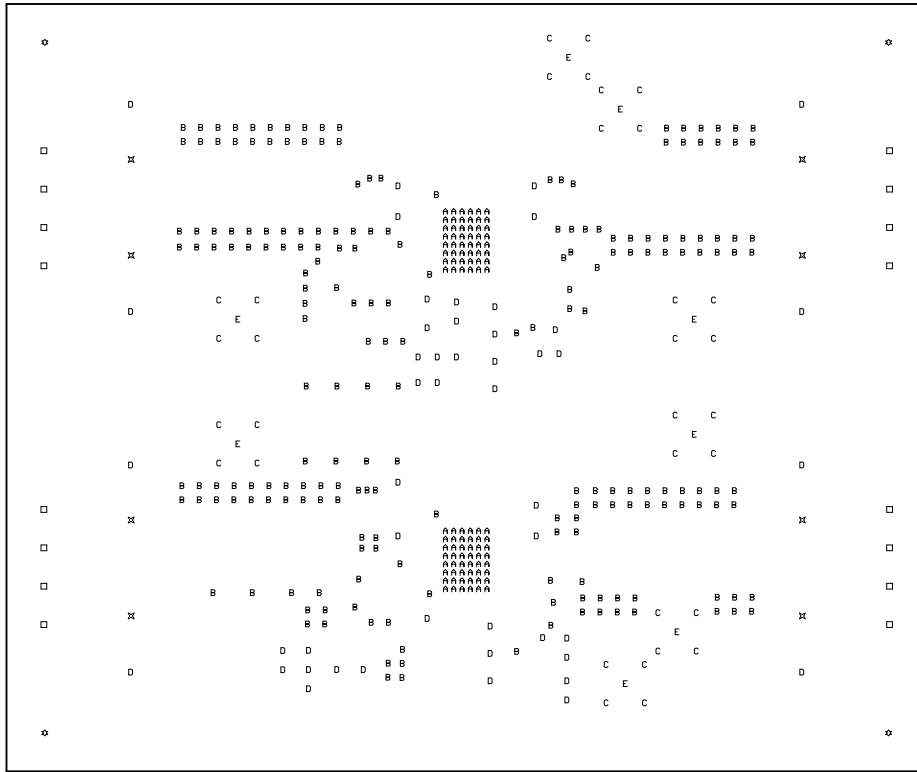


Figure 15. Bottom Solder



DRILL TABLE:

Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Hole Tolerance (mils)
A	96	7.87mil (0.200mm)	PTH	Round	+0/-7.87
B	205	15.00mil (0.381mm)	PTH	Round	+0/-15
C	32	38.00mil (0.965mm)	PTH	Round	+/-3
D	48	40.00mil (1.016mm)	PTH	Round	+/-3
□	16	52.00mil (1.321mm)	PTH	Round	
E	8	68.00mil (1.727mm)	PTH	Round	+/-3
☆	4	125.98mil (3.200mm)	PTH	Round	
⊗	8	214.57mil (5.450mm)	PTH	Round	
	417 Total				

Figure 16. Drill Drawing



Figure 17. Board Dimensions

5 Schematic and Bill of Materials

The EVM schematics and BOM for both variants of the EVM are shown in this section.

5.1 Schematic

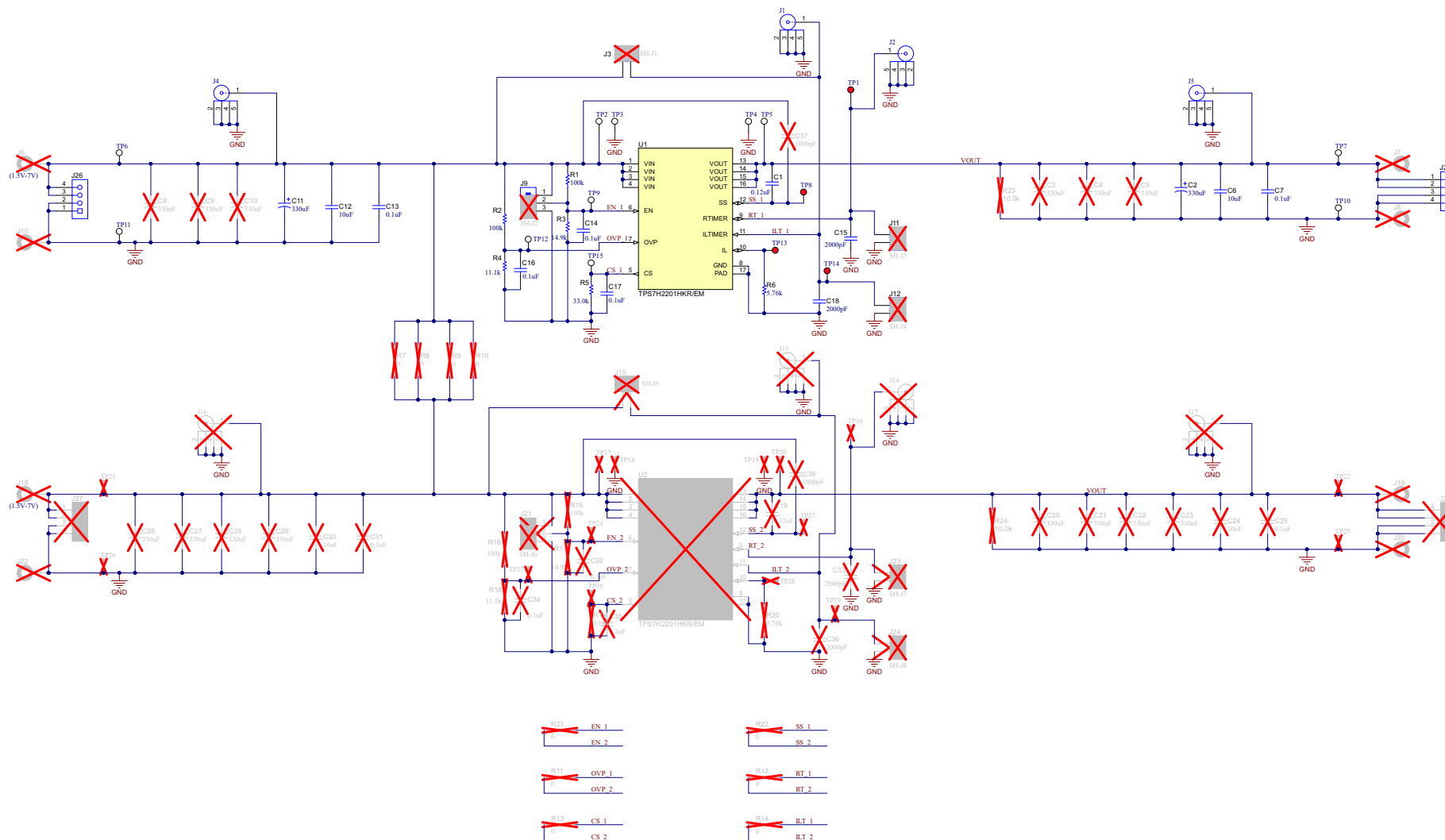


Figure 18. Schematic for TPS7H2201EVM-CVAL

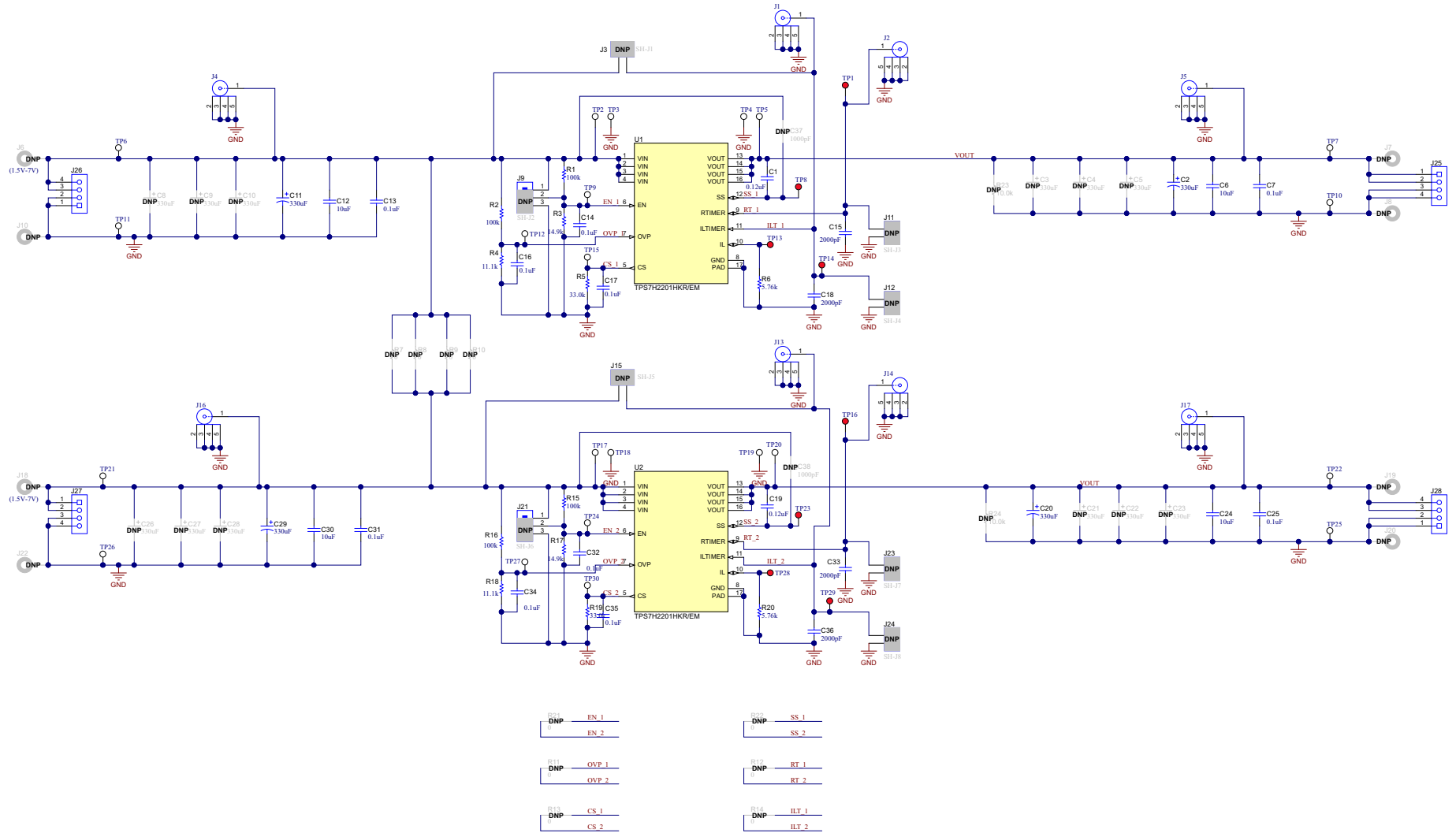


Figure 19. Schematic for TPS7H2201EVMCVAL-D in Redundancy Configuration

5.2 Bill of Materials

Table 4. Bill of Materials for TPS7H2201EVM-CVAL

Description	Designator	PartNumber	QTY	Manufacturer	PackageReference	Value	Alternate Manufacturer	Alternate PartNumber	Fitted
Printed Circuit Board	!PCB1	SLHR008	1	Any					Fitted
CAP, CERM, 0.12 uF, 50 V, +/- 10%, X7R, 0805	C1	08055C124KAT2A	1	AVX	0805	0.12uF			Fitted
CAP, Tantalum Polymer, 330 uF, 10 V, +/- 20%, 0.006 ohm, 7343-43 SMD	C2, C11	T530X337M010ATE006	2	Kemet	7343-43	330uF			Fitted
CAP, CERM, 10 uF, 50 V, +/- 10%, X5R, 1206	C6, C12	GRM31CR61H106KA12L	2	MuRata	1206	10uF			Fitted
CAP, CERM, 0.1 uF, 50 V, +/- 5%, X7R, 1206	C7, C13	12065C104JAT2A	2	AVX	1206	0.1uF			Fitted
CAP, CERM, 0.1 uF, 25 V, +/- 5%, X7R, 0805	C14, C16, C17	08053C104JAZ2A	3	AVX	0805	0.1uF			Fitted
CAP, CERM, 2000 pF, 50 V, +/- 5%, COG/NP0, 1206	C15, C18	12065A202JAT2A	2	AVX	1206	2000pF			Fitted
Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	H1, H2, H3, H4	NY PMS 440 0025 PH	4	B&F Fastener Supply	Screw				Fitted
Standoff, Hex, 0.5"L #4-40 Nylon	H5, H6, H7, H8	1902C	4	Keystone	Standoff				Fitted
Compact Probe Tip Circuit Board Test Points, TH, 25 per	J1, J2, J4, J5	131-5031-00	4	Tektronix	TH Scope Probe				Fitted
Header, 100mil, 2x1, Gold, TH	J3, J11, J12	HTSW-102-07-G-S	3	Samtec	Header, 100mil, 2x1, TH				Fitted
Header, 100mil, 3x1, Gold, TH	J9	TSW-103-07-G-S	1	Samtec	3x1 Header				Fitted
Terminal Block, 4x1, 5.08mm, TH	J25, J26	39544-3004	2	Molex	4x1 Terminal Block				Fitted
Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll	LBL1	THT-14-423-10	1	Brady	PCB Label 0.650 x 0.200 inch				Fitted
RES, 100 k, 0.1%, 0.125 W, 0805	R1, R2	RT0805BRD07100KL	2	Yageo America	0805	100k			Fitted
RES, 14.9 k, 0.1%, 0.125 W, 0805	R3	RT0805BRD0714K9L	1	Yageo America	0805	14.9k			Fitted
RES, 11.1 k, 0.1%, 0.2 W, 0805	R4	PTN0805E1112BST1	1	Vishay Thin Film	0805	11.1k			Fitted
RES, 33.0 k, 0.1%, 0.125 W, 0805	R5	RG2012P-333-B-T5	1	Susumu Co Ltd	0805	33.0k			Fitted
RES, 5.76 k, 1%, 0.125 W, AEC-Q200 Grade 0, 0805	R6	CRCW08055K76FKEA	1	Vishay-Dale	0805	5.76k			Fitted
Test Point, Miniature, Red, TH	TP1, TP8, TP13, TP14	5000	4	Keystone	Red Miniature Testpoint				Fitted
Test Point, Miniature, White, TH	TP2, TP3, TP4, TP5, TP6, TP7, TP9, TP10, TP11, TP12, TP15	5002	11	Keystone	White Miniature Testpoint				Fitted
Radiation Hardened 7-V, 6-A Load Switch, HKR0016A (CFP-16)	U1	TPS7H2201HKR/EM	1	Texas Instruments	HKR0016A		Texas Instruments		Fitted

Table 4. Bill of Materials for TPS7H2201EVM-CVAL (continued)

Description	Designator	PartNumber	QTY	Manufacturer	PackageReference	Value	Alternate Manufacturer	Alternate PartNumber	Fitted
CAP, Tantalum Polymer, 330 uF, 10 V, +/- 20%, 0.006 ohm, 7343-43 SMD	C3, C4, C5, C8, C9, C10, C20, C21, C22, C23, C26, C27, C28, C29	T530X337M010ATE006	0	Kemet	7343-43	330uF			Not Fitted
CAP, CERM, 0.12 uF, 50 V, +/- 10%, X7R, 0805	C19	08055C124KAT2A	0	AVX	0805	0.12uF			Not Fitted
CAP, CERM, 10 uF, 50 V, +/- 10%, X5R, 1206	C24, C30	GRM31CR61H106KA12L	0	MuRata	1206	10uF			Not Fitted
CAP, CERM, 0.1 uF, 50 V, +/- 5%, X7R, 1206	C25, C31	12065C104JAT2A	0	AVX	1206	0.1uF			Not Fitted
CAP, CERM, 0.1 uF, 25 V, +/- 5%, X7R, 0805	C32, C34, C35	08053C104JAZ2A	0	AVX	0805	0.1uF			Not Fitted
CAP, CERM, 2000 pF, 50 V, +/- 5%, COG/NP0, 1206	C33, C36	12065A202JAT2A	0	AVX	1206	2000pF			Not Fitted
CAP, CERM, 1000 pF, 50 V, +/- 5%, X7R, 0805	C37, C38	C0805C102J5RACTU	0	Kemet	0805	1000pF			Not Fitted
Fiducial mark. There is nothing to buy or mount.	FID1, FID2, FID3	N/A	0	N/A	N/A				Not Fitted
Standard Banana Jack, Uninsulated, 5.5mm	J6, J7, J8, J10, J18, J19, J20, J22	575-4	0	Keystone	Keystone_575-4				Not Fitted
Compact Probe Tip Circuit Board Test Points, TH, 25 per	J13, J14, J16, J17	131-5031-00	0	Tektronix	TH Scope Probe				Not Fitted
Header, 100mil, 2x1, Gold, TH	J15, J23, J24	HTSW-102-07-G-S	0	Samtec	Header, 100mil, 2x1, TH				Not Fitted
Header, 100mil, 3x1, Gold, TH	J21	TSW-103-07-G-S	0	Samtec	3x1 Header				Not Fitted
Terminal Block, 4x1, 5.08mm, TH	J27, J28	39544-3004	0	Molex	4x1 Terminal Block				Not Fitted
RES, 0, 5%, 1 W, 2512	R7, R8, R9, R10	RC6432J000CS	0	Samsung	2512	0			Not Fitted
RES, 0, 5%, 0.125 W, AEC-Q200 Grade 0, 0805	R11, R12, R13, R14, R21, R22	CRCW08050000Z0EA	0	Vishay-Dale	0805	0			Not Fitted
RES, 100 k, 0.1%, 0.125 W, 0805	R15, R16	RT0805BRD07100KL	0	Yageo America	0805	100k			Not Fitted
RES, 14.9 k, 0.1%, 0.125 W, 0805	R17	RT0805BRD0714K9L	0	Yageo America	0805	14.9k			Not Fitted
RES, 11.1 k, 0.1%, 0.2 W, 0805	R18	PTN0805E1112BST1	0	Vishay Thin Film	0805	11.1k			Not Fitted
RES, 33.0 k, 0.1%, 0.125 W, 0805	R19	RG2012P-333-B-T5	0	Susumu Co Ltd	0805	33.0k			Not Fitted
RES, 5.76 k, 1%, 0.125 W, AEC-Q200 Grade 0, 0805	R20	CRCW08055K76FKEA	0	Vishay-Dale	0805	5.76k			Not Fitted
RES, 10.0 k, 1%, 0.2 W, 0805	R23, R24	MCU08050C1002FP500	0	Vishay/Beyschlag	0805	10.0k			Not Fitted
Shunt, 100mil, Flash Gold, Black	SH-J1, SH-J2, SH-J3, SH-J4, SH-J5, SH-J6, SH-J7, SH-J8	SPC02SYAN	0	Sullins Connector Solutions	Closed Top 100mil Shunt	1x2			Not Fitted
Test Point, Miniature, Red, TH	TP16, TP23, TP28, TP29	5000	0	Keystone	Red Miniature Testpoint				Not Fitted

Table 4. Bill of Materials for TPS7H2201EVM-CVAL (continued)

Description	Designator	PartNumber	QTY	Manufacturer	PackageReference	Value	Alternate Manufacturer	Alternate PartNumber	Fitted
Test Point, Miniature, White, TH	TP17, TP18, TP19, TP20, TP21, TP22, TP24, TP25, TP26, TP27, TP30	5002	0	Keystone	White Miniature Testpoint				Not Fitted
Radiation Hardened 7-V, 6-A Load Switch, HKR0016A (CFP-16)	U2	TPS7H2201HKR/EM	0	Texas Instruments	HKR0016A		Texas Instruments		Not Fitted

Table 5. Bill of Materials for TPS7H2201EVMCVAL-D

Description	Designator	PartNumber	Quantity	Manufacturer	PackageReference	Value	Alternate Manufacturer	Alternate PartNumber	Fitted
Printed Circuit Board	IPCB1	SLHR008	1	Any					Fitted
CAP, CERM, 0.12 uF, 50 V, +/- 10%, X7R, 0805	C1, C19	08055C124KAT2A	2	AVX	0805	0.12uF			Fitted
CAP, Tantalum Polymer, 330 uF, 10 V, +/- 20%, 0.006 ohm, 7343-43 SMD	C2, C11, C20, C29	T530X337M010AT E006	4	Kemet	7343-43	330uF			Fitted
CAP, CERM, 10 uF, 50 V, +/- 10%, X5R, 1206	C6, C12, C24, C30	GRM31CR61H106 KA12L	4	MuRata	1206	10uF			Fitted
CAP, CERM, 0.1 uF, 50 V, +/- 5%, X7R, 1206	C7, C13, C25, C31	12065C104JAT2A	4	AVX	1206	0.1uF			Fitted
CAP, CERM, 0.1 uF, 25 V, +/- 5%, X7R, 0805	C14, C16, C17, C32, C34, C35	08053C104JAZ2A	6	AVX	0805	0.1uF			Fitted
CAP, CERM, 2000 pF, 50 V, +/- 5%, C0G/NP0, 1206	C15, C18, C33, C36	12065A202JAT2A	4	AVX	1206	2000pF			Fitted
Machine Screw, Round, #4-40 x 1/4, Nylon, Phillips panhead	H1, H2, H3, H4	NY PMS 440 0025 PH	4	B-and-F Fastener Supply	Screw				Fitted
Standoff, Hex, 0.5"L #4-40 Nylon	H5, H6, H7, H8	1902C	4	Keystone	Standoff				Fitted
Compact Probe Tip Circuit Board Test Points, TH, 25 per	J1, J2, J4, J5, J13, J14, J16, J17	131-5031-00	8	Tektronix	TH Scope Probe				Fitted
Header, 100mil, 2x1, Gold, TH	J3, J11, J12, J15, J23, J24	HTSW-102-07-G-S	6	Samtec	Header, 100mil, 2x1, TH				Fitted
Header, 100mil, 3x1, Gold, TH	J9, J21	TSW-103-07-G-S	2	Samtec	3x1 Header				Fitted

Table 5. Bill of Materials for TPS7H2201EVMCVL-D (continued)

Description	Designator	PartNumber	Quantity	Manufacturer	PackageReference	Value	Alternate Manufacturer	Alternate PartNumber	Fitted
Terminal Block, 4x1, 5.08mm, TH	J25, J26, J27, J28	39544-3004	4	Molex	4x1 Terminal Block				Fitted
Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll	LBL1	THT-14-423-10	1	Brady	PCB Label 0.650 x 0.200 inch				Fitted
RES, 100 k, 0.1%, 0.125 W, 0805	R1, R2, R15, R16	RT0805BRD07100 KL	4	Yageo America	0805	100k			Fitted
RES, 14.9 k, 0.1%, 0.125 W, 0805	R3, R17	RT0805BRD0714K 9L	2	Yageo America	0805	14.9k			Fitted
RES, 11.1 k, 0.1%, 0.2 W, 0805	R4, R18	PTN0805E1112BS T1	2	Vishay Thin Film	0805	11.1k			Fitted
RES, 33.0 k, 0.1%, 0.125 W, 0805	R5, R19	RG2012P-333-B-T5	2	Susumu Co Ltd	0805	33.0k			Fitted
RES, 5.76 k, 1%, 0.125 W, AEC-Q200 Grade 0, 0805	R6, R20	CRCW08055K76F KEA	2	Vishay-Dale	0805	5.76k			Fitted
Test Point, Miniature, Red, TH	TP1, TP8, TP13, TP14, TP16, TP23, TP28, TP29	5000	8	Keystone	Red Miniature Testpoint				Fitted
Test Point, Miniature, White, TH	TP2, TP3, TP4, TP5, TP6, TP7, TP9, TP10, TP11, TP12, TP15, TP17, TP18, TP19, TP20, TP21, TP22, TP24, TP25, TP26, TP27, TP30	5002	22	Keystone	White Miniature Testpoint				Fitted
Radiation Hardened 7-V, 6-A Load Switch, HKR0016A (CFP-16)	U1, U2	TPS7H2201HKR/EM	2	Texas Instruments	HKR0016A		Texas Instruments		Fitted
CAP, Tantalum Polymer, 330 uF, 10 V, +/- 20%, 0.006 ohm, 7343-43 SMD	C3, C4, C5, C8, C9, C10, C21, C22, C23, C26, C27, C28	T530X337M010AT E006	0	Kemet	7343-43	330uF			Not Fitted
CAP, CERM, 1000 pF, 50 V, +/- 5%, X7R, 0805	C37, C38	C0805C102J5RAC TU	0	Kemet	0805	1000pF			Not Fitted
Fiducial mark. There is nothing to buy or mount.	FID1, FID2, FID3	N/A	0	N/A	N/A				Not Fitted
Standard Banana Jack, Uninsulated, 5.5mm	J6, J7, J8, J10, J18, J19, J20, J22	575-4	0	Keystone	Keystone_575-4				Not Fitted

Table 5. Bill of Materials for TPS7H2201EVMCVAL-D (continued)

Description	Designator	PartNumber	Quantity	Manufacturer	PackageReference	Value	Alternate Manufacturer	Alternate PartNumber	Fitted
RES, 0, 5%, 1 W, 2512	R7, R8, R9, R10	RC6432J000CS	0	Samsung	2512	0			Not Fitted
RES, 0, 5%, 0.125 W, AEC-Q200 Grade 0, 0805	R11, R12, R13, R14, R21, R22	CRCW08050000Z0 EA	0	Vishay-Dale	0805	0			Not Fitted
RES, 10.0 k, 1%, 0.2 W, 0805	R23, R24	MCU08050C1002F P500	0	Vishay/Beyschlag	0805	10.0k			Not Fitted
Shunt, 100mil, Flash Gold, Black	SH-J1, SH-J2, SH-J3, SH-J4, SH-J5, SH-J6, SH-J7, SH-J8	SPC02SYAN	0	Sullins Connector Solutions	Closed Top 100mil Shunt	1x2			Not Fitted

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